

2102061-9 ✓ ACTIVE

Mezalok | AMP Mezalok

TE Internal #: 2102061-9

AMP Mezalok, PCB Mount Receptacle, Vertical, Board-to-Board,
114 Position, 1.27mm [.05in] Centerline, Gold, Printed Circuit Board

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Receptacle**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **114**

Centerline (Pitch): **1.27 mm [.05 in]**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Rows	6
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	114
Board-to-Board Configuration	Parallel

Electrical Characteristics

Dielectric Withstanding Voltage (Max)	750 VAC
Operating Voltage	250 VAC

Contact Features

Contact Layout	Matrix
Mating Tab Width	.43 mm[.017 in]
Mating Tab Thickness	.46 mm[.018 in]
Contact Shape & Form	Square
Contact Mating Area Plating Material Finish	Bright



Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Beryllium Copper
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	1.27 μ m[49.9999 μ in]
Contact Type	Socket
Contact Current Rating (Max)	1.5 A

Termination Features

Termination Method to Printed Circuit Board	Surface Mount - Solder Ball
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Mechanical Attachment

PCB Mount Alignment Type	None
PCB Mount Retention Type	Solder Ball
Mating Alignment	With
Mating Alignment Type	Polarizing Tab
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Top
Centerline (Pitch)	1.27 mm[.05 in]
Housing Color	Natural
Housing Material	LCP (Liquid Crystal Polymer)

Dimensions

Connector Height	14 mm[.55 in]
Row-to-Row Spacing	1.27 mm[.05 in]
Stack Height	18 mm[.709 in]
PCB Thickness (Recommended)	2.36 mm[.093 in]

Usage Conditions

Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
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Operation/Application

Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal



Industry Standards

Industry Standard	VITA 61
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Packaging Features

Packaging Quantity	100
Packaging Method	Tape & Reel

Other

Comment	Conforms to requirement of VITA 61 (VITA 42 Alternate)., VITA 42 and VITA 61 are not intermateable but are footprint and XMC architecture compatible.
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2021 (211) Candidate List Declared Against: JAN 2021 (211) SVHC > Threshold: Pb (6% in solder balls) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Reflow solder capable to 260°C

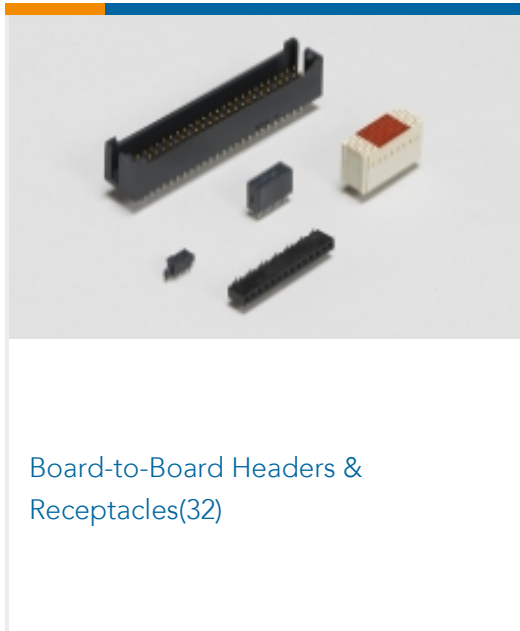
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Also in the Series | AMP Mezalok



Customers Also Bought





Documents

Product Drawings

[Mezalok, Socket, 114 p, 18 mm, 50 Au, TL](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_2102061-9_K.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2102061-9_K.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2102061-9_K.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[Mezalok Connector Brochure](#)

English

[SOSA Aligned Interconnect Solutions](#)

English

Product Specifications

[Product Specification](#)

English